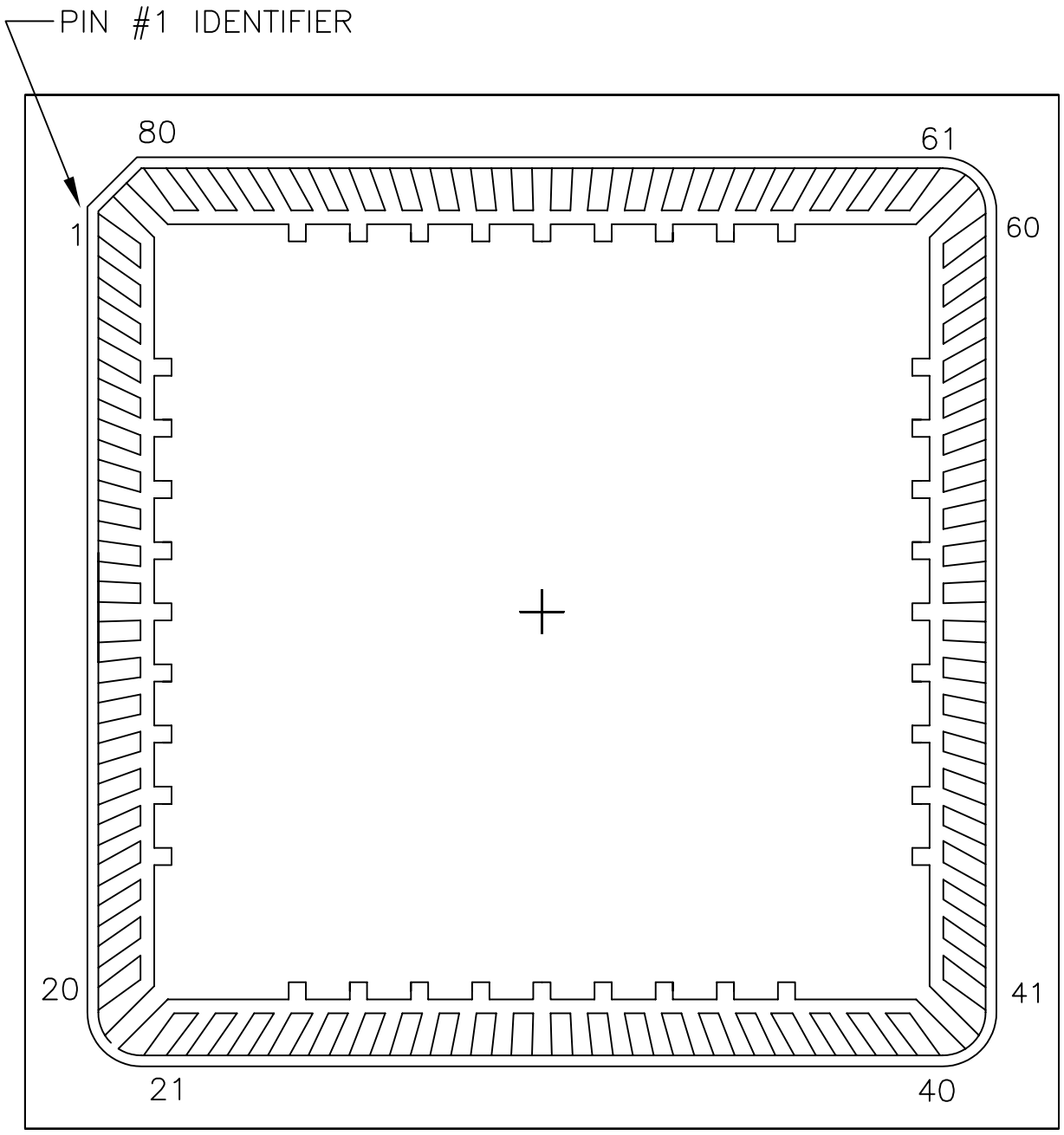
SEMPAC REVISIONS			
ECN NO.	DATE	DESCRIPTION	APPROVED
10820	12/04/06	PRODUCTION RELEASE	D.MORRIS

DRAWN BY	DATE	APP BY	DATE
C. CRUZ	12/04/06	P. FLASKERUD	12/04/06



DEVICE TYPE:		
CUSTOMER:	DIE SIZE:	
WIRE TYPE/ SIZE:	NO. OF WIRES:	
THIRD ANGLE PROJECTION	PACKAGE SIZE:	12.000mm X 12.000mm
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETER DO NOT SCALE DRAWING	DIE PAD SIZE:	9.000mm X 9.000mm

SEMPAC PART NO.
MLP12X12-80-0P-01-B

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80 LEAD 12mm X 12mm MLP
Open-Pak™ BONDING DIAGRAM

SIZE	PART NO.	REV
A	MLP12X12-80-0P-01	1

SCALE 32X	CAD FILE MLP12X12-80-OP-01-B-R1.DWG	SHEET 1 OF 1